

N-channel 600 V, 85 mΩ typ., 30 A MDmesh™ M6 Power MOSFET in a D²PAK package

Datasheet - production data

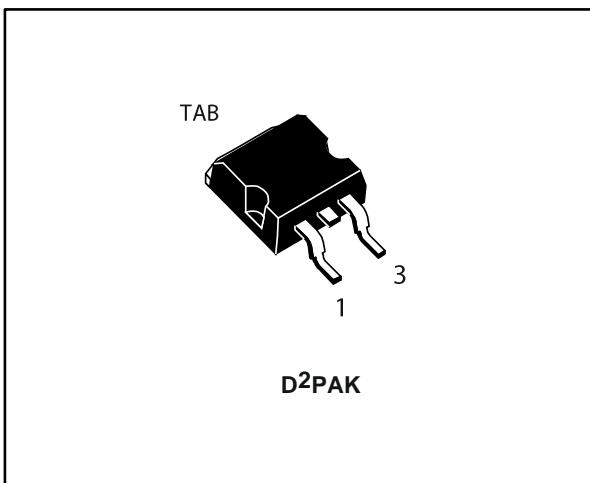
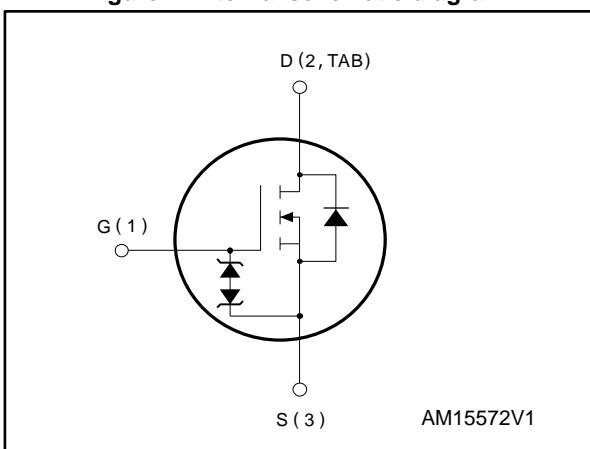


Figure 1: Internal schematic diagram



Features

| Order code | V _{DS} | R _{DS(on)} max. | I _D |
|------------|-----------------|--------------------------|----------------|
| STB36N60M6 | 600 V | 99 mΩ | 30 A |

- Reduced switching losses
- Lower R_{DS(on)} x area vs previous generation
- Low gate input resistance
- 100% avalanche tested
- Zener-protected

Applications

- Switching applications

Description

The new MDmesh™ M6 technology incorporates the most recent advancements to the well-known and consolidated MDmesh family of SJ MOSFETs. STMicroelectronics builds on the previous generation of MDmesh devices through its new M6 technology, which combines excellent R_{DS(on)} * area improvement with one of the most effective switching behaviors available, as well as a user-friendly experience for maximum end-application efficiency.

Table 1: Device summary

| Order code | Marking | Package | Packing |
|------------|---------|--------------------|---------------|
| STB36N60M6 | 36N60M6 | D ² PAK | Tape and reel |

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1 Electrical ratings

Table 2: Absolute maximum ratings

| Symbol | Parameter | Value | Unit |
|---------------|---|------------|------------------|
| V_{GS} | Gate-source voltage | ± 25 | V |
| I_D | Drain current (continuous) at $T_c = 25^\circ\text{C}$ | 30 | A |
| I_D | Drain current (continuous) at $T_c = 100^\circ\text{C}$ | 19 | A |
| $I_D^{(1)}$ | Drain current (pulsed) | 102 | A |
| P_{TOT} | Total dissipation at $T_c = 25^\circ\text{C}$ | 208 | W |
| $dv/dt^{(2)}$ | Peak diode recovery voltage slope | 15 | V/ns |
| $dv/dt^{(3)}$ | MOSFET dv/dt ruggedness | 50 | |
| T_J | Operating junction temperature range | -55 to 150 | $^\circ\text{C}$ |
| T_{stg} | Storage temperature range | | |

Notes:

(1)Pulse width limited by safe operating area.

(2) $I_{SD} \leq 30 \text{ A}$, $di/dt = 400 \text{ A}/\mu\text{s}$; V_{DS} peak < $V_{(BR)DSS}$, $V_{DD} = 400 \text{ V}$ (3) $V_{DS} \leq 480 \text{ V}$ **Table 3: Thermal data**

| Symbol | Parameter | Value | Unit |
|----------------|--|-------|---------------------------|
| $R_{thj-case}$ | Thermal resistance junction-case | 0.6 | $^\circ\text{C}/\text{W}$ |
| $R_{thj-pcb}$ | Thermal resistance junction-pcb ⁽¹⁾ | 30 | |

Notes:(1)When mounted on 1 inch² FR-4, 2 Oz copper board.**Table 4: Avalanche characteristics**

| Symbol | Parameter | Value | Unit |
|----------|---|-------|------|
| I_{AR} | Avalanche current, repetitive or not repetitive (pulse width limited by $T_{jmax.}$) | 5 | A |
| E_{AS} | Single pulse avalanche energy (starting $T_j = 25^\circ\text{C}$, $I_D = I_{AR}$, $V_{DD} = 50 \text{ V}$) | 750 | mJ |

2 Electrical characteristics

$T_C = 25^\circ\text{C}$ unless otherwise specified

Table 5: On/off-state

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|---------------|-----------------------------------|---|------|------|---------|------------------|
| $V_{(BR)DSS}$ | Drain-source breakdown voltage | $V_{GS} = 0 \text{ V}$, $I_D = 1 \text{ mA}$ | 600 | | | V |
| I_{DSS} | Zero gate voltage drain current | $V_{GS} = 0 \text{ V}$, $V_{DS} = 600 \text{ V}$ | | | 1 | μA |
| | | $V_{GS} = 0 \text{ V}$, $V_{DS} = 600 \text{ V}$; $T_C = 125^\circ\text{C}$ (1) | | | 100 | μA |
| I_{GSS} | Gate body leakage current | $V_{DS} = 0 \text{ V}$, $V_{GS} = \pm 25 \text{ V}$ | | | ± 5 | μA |
| $V_{GS(th)}$ | Gate threshold voltage | $V_{DS} = V_{GS}$, $I_D = 250 \mu\text{A}$ | 3.25 | 4 | 4.75 | V |
| $R_{DS(on)}$ | Static drain-source on-resistance | $V_{GS} = 10 \text{ V}$, $I_D = 15 \text{ A}$ | | 85 | 99 | $\text{m}\Omega$ |

Notes:

(1)Defined by design, not subject to production test.

Table 6: Dynamic

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|-------------------|-------------------------------|---|------|------|------|----------|
| C_{iss} | Input capacitance | $V_{DS} = 100 \text{ V}$, $f = 1 \text{ MHz}$, $V_{GS} = 0 \text{ V}$ | - | 1960 | - | pF |
| C_{oss} | Output capacitance | | - | 93 | - | pF |
| C_{rss} | Reverse transfer capacitance | | - | 6 | - | pF |
| $C_{oss eq.}$ (1) | Equivalent output capacitance | $V_{DS} = 0$ to 480 V , $V_{GS} = 0 \text{ V}$ | - | 332 | - | pF |
| R_G | Intrinsic gate resistance | $f = 1 \text{ MHz}$ open drain | - | 1.6 | - | Ω |
| Q_g | Total gate charge | $V_{DD} = 480 \text{ V}$, $I_D = 30 \text{ A}$, $V_{GS} = 0$ to 10 V , (See Figure 15: "Test circuit for gate charge behavior") | - | 44.3 | - | nC |
| Q_{gs} | Gate-source charge | | - | 10.1 | - | nC |
| Q_{gd} | Gate-drain charge | | - | 25 | - | nC |

Notes:

(1) $C_{oss eq.}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS} .

Table 7: Switching times

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|--------------|---------------------|--|------|------|------|------|
| $t_{d(on)}$ | Turn-on delay time | $V_{DD} = 300 \text{ V}$, $I_D = 15 \text{ A}$, $R_G = 4.7 \Omega$, $V_{GS} = 10 \text{ V}$ (See Figure 14: "Test circuit for resistive load switching times" and Figure 19: "Switching time waveform") | - | 15.2 | - | ns |
| t_r | Rise time | | - | 5.3 | - | ns |
| $t_{d(off)}$ | Turn-off delay time | | - | 50.2 | - | ns |
| t_f | Fall time | | - | 7.3 | - | ns |

Table 8: Source-drain diode

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|-----------------|-------------------------------|---|------|------|------|---------------|
| I_{SD} | Source-drain current | | - | | 30 | A |
| $I_{SDM}^{(1)}$ | Source-drain current (pulsed) | | - | | 102 | A |
| $V_{SD}^{(2)}$ | Forward on voltage | $I_{SD} = 30 \text{ A}, V_{GS} = 0 \text{ V}$ | - | | 1.6 | V |
| t_{rr} | Reverse recovery time | $I_{SD} = 30 \text{ A}, \text{di/dt} = 100 \text{ A}/\mu\text{s}, V_{DD} = 60 \text{ V}, (\text{see Figure 16: "Test circuit for inductive load switching and diode recovery times"})$ | - | 340 | | ns |
| Q_{rr} | Reverse recovery charge | | - | 5.3 | | μC |
| I_{RRM} | Reverse recovery current | | - | 31 | | A |
| t_{rr} | Reverse recovery time | $I_{SD} = 30 \text{ A}, \text{di/dt} = 100 \text{ A}/\mu\text{s}, V_{DD} = 60 \text{ V}, T_j = 150 \text{ }^\circ\text{C} (\text{see Figure 16: "Test circuit for inductive load switching and diode recovery times"})$ | - | 430 | | ns |
| Q_{rr} | Reverse recovery charge | | - | 7.7 | | μC |
| I_{RRM} | Reverse recovery current | | - | 36 | | A |

Notes:

(1)Pulse width limited by safe operating area.

(2)Pulsed: pulse duration = 300 μs , duty cycle 1.5%.

2.1 Electrical characteristics (curves)

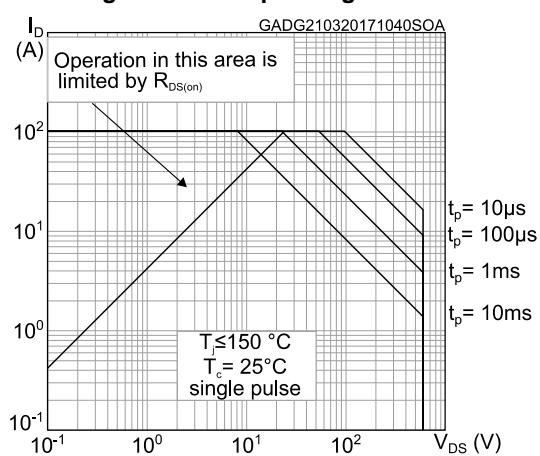
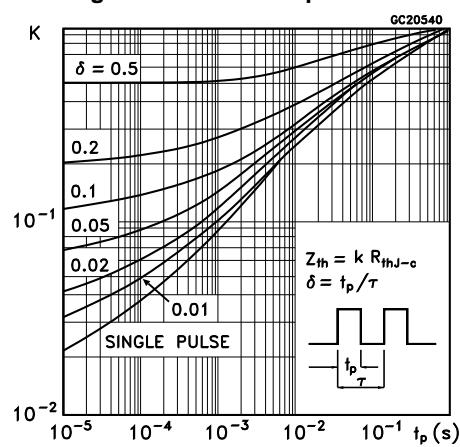
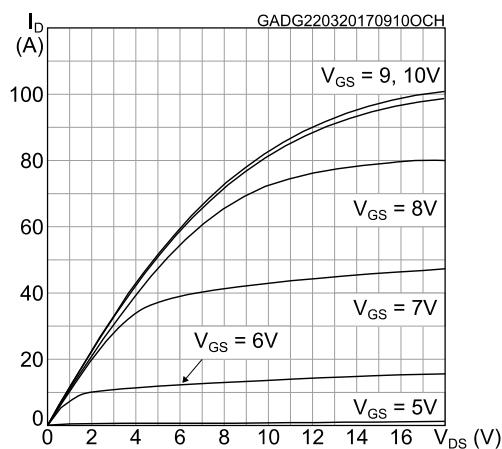
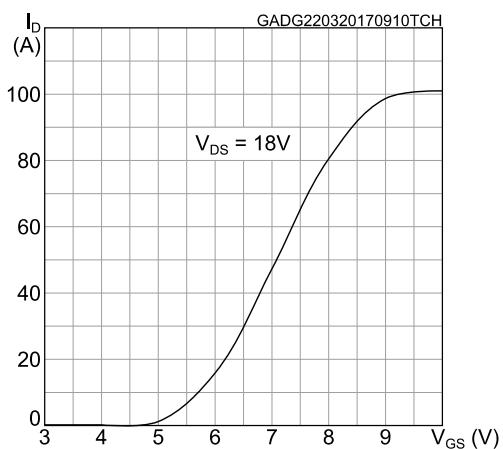
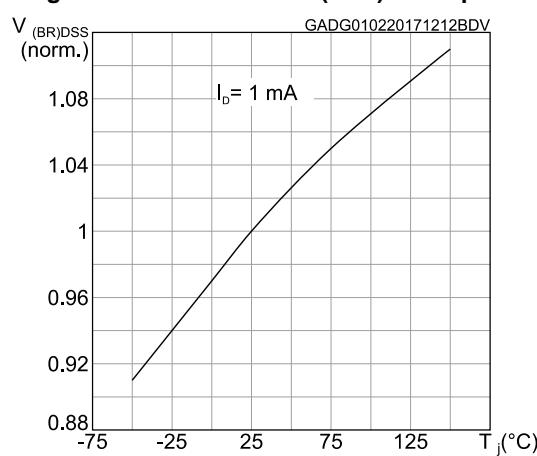
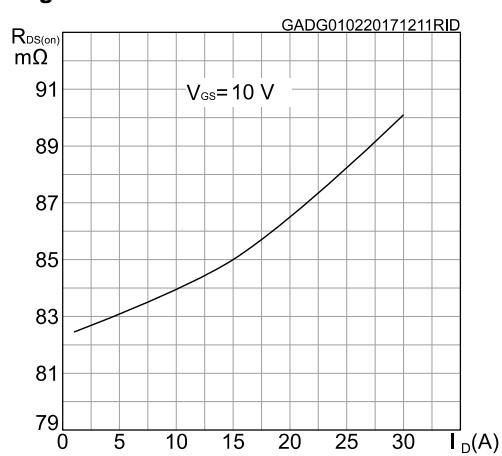
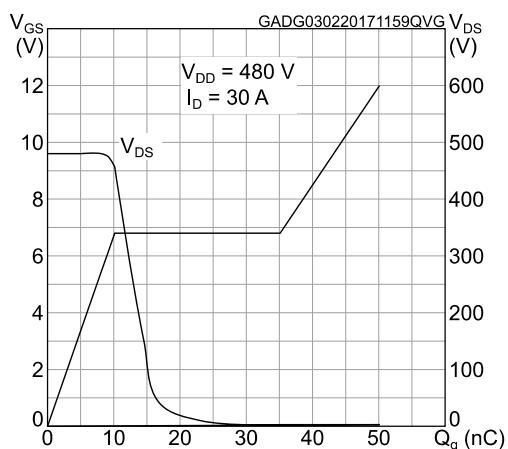
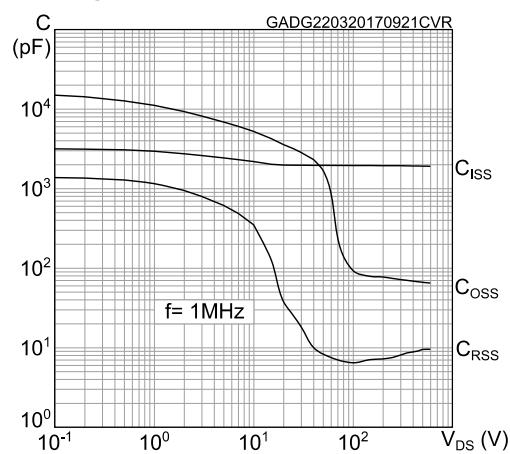
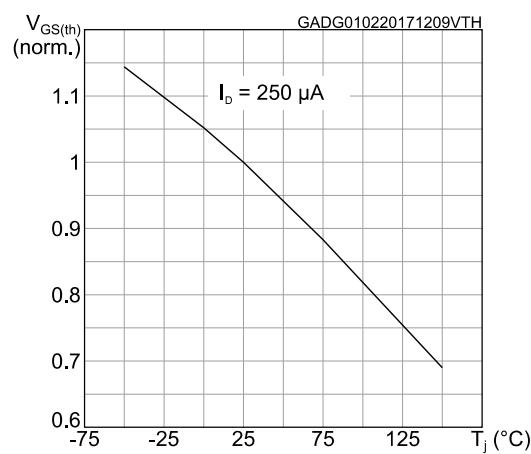
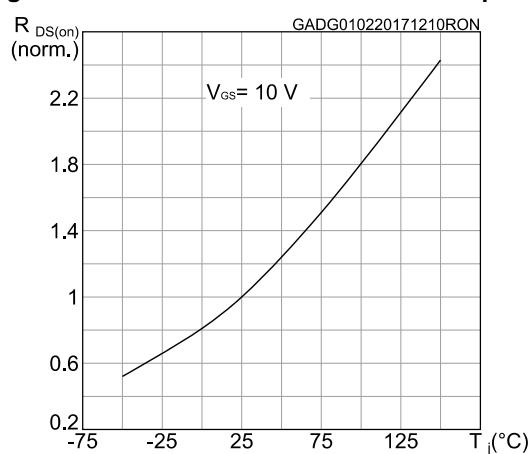
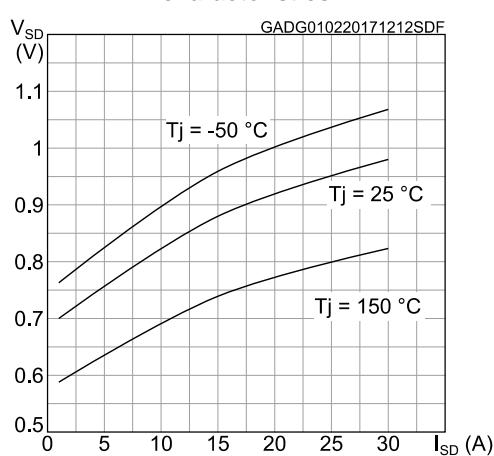
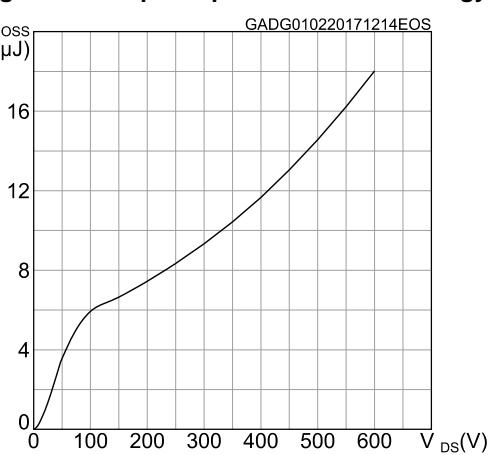
Figure 2: Safe operating area**Figure 3: Thermal impedance****Figure 4: Output characteristics****Figure 5: Transfer characteristics****Figure 6: Normalized VBR(DSS)vs temperature****Figure 7: Static drain-source on-resistance**

Figure 8: Gate charge vs gate-source voltage**Figure 9: Capacitance variations****Figure 10: Normalized gate threshold voltage vs temperature****Figure 11: Normalized on-resistance vs temperature****Figure 12: Source-drain diode forward characteristics****Figure 13: Output capacitance stored energy**

3 Test circuits

Figure 14: Test circuit for resistive load switching times



Figure 15: Test circuit for gate charge behavior

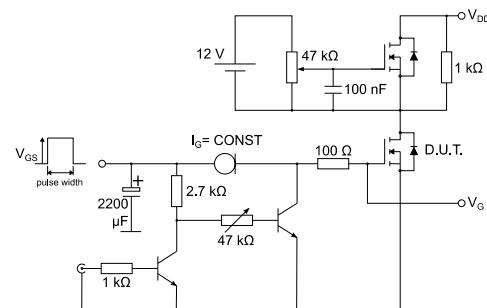


Figure 16: Test circuit for inductive load switching and diode recovery times

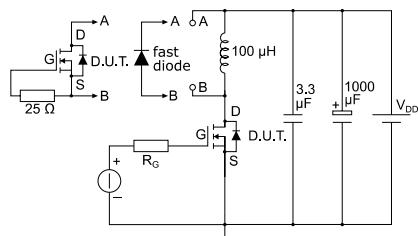


Figure 17: Unclamped inductive load test circuit

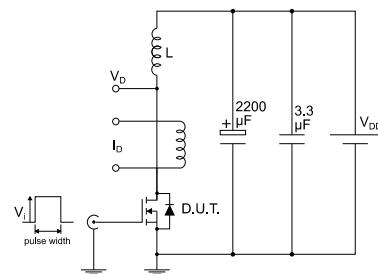


Figure 18: Unclamped inductive waveform

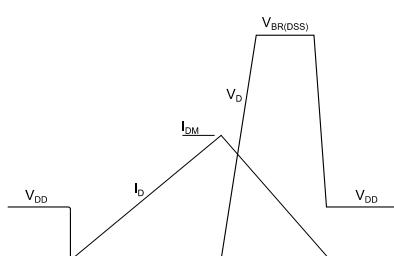
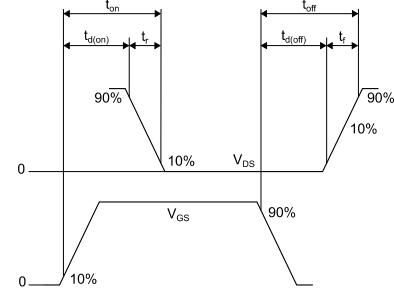


Figure 19: Switching time waveform



4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com.
ECOPACK® is an ST trademark.

4.1 D2PAK type A package information

Figure 20: D²PAK (TO-263) type A package outline

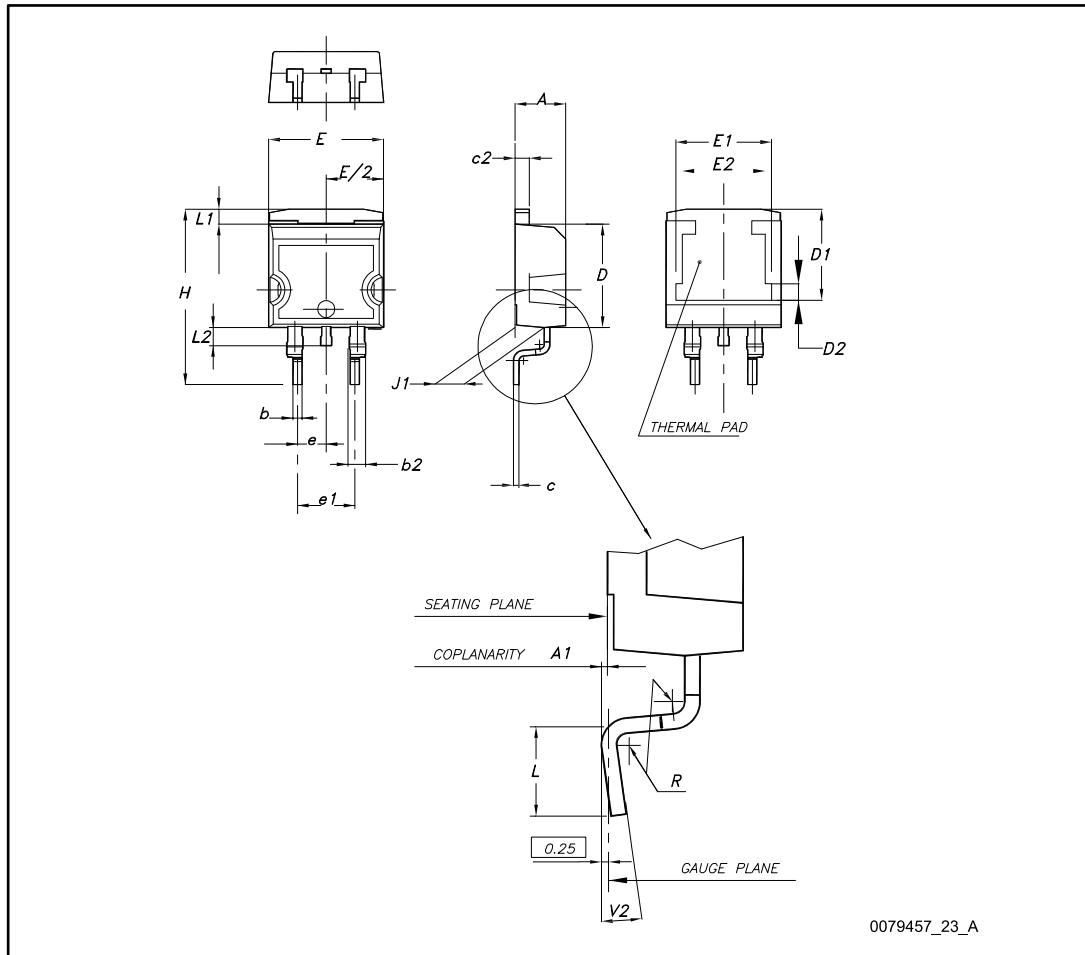
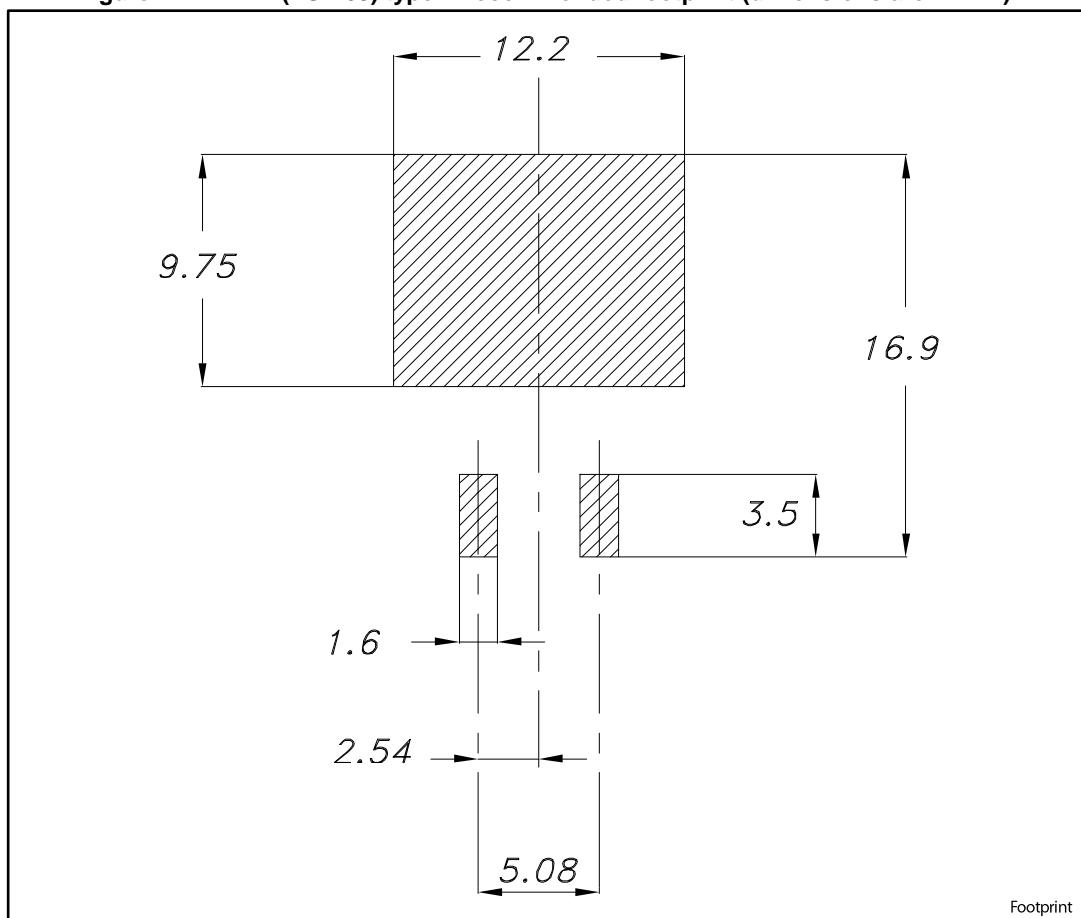


Table 9: D²PAK (TO-263) type A package mechanical data

| Dim. | mm | | |
|------|-------|------|-------|
| | Min. | Typ. | Max. |
| A | 4.40 | | 4.60 |
| A1 | 0.03 | | 0.23 |
| b | 0.70 | | 0.93 |
| b2 | 1.14 | | 1.70 |
| c | 0.45 | | 0.60 |
| c2 | 1.23 | | 1.36 |
| D | 8.95 | | 9.35 |
| D1 | 7.50 | 7.75 | 8.00 |
| D2 | 1.10 | 1.30 | 1.50 |
| E | 10.00 | | 10.40 |
| E1 | 8.50 | 8.70 | 8.90 |
| E2 | 6.85 | 7.05 | 7.25 |
| e | | 2.54 | |
| e1 | 4.88 | | 5.28 |
| H | 15.00 | | 15.85 |
| J1 | 2.49 | | 2.69 |
| L | 2.29 | | 2.79 |
| L1 | 1.27 | | 1.40 |
| L2 | 1.30 | | 1.75 |
| R | | 0.40 | |
| V2 | 0° | | 8° |

Figure 21: D²PAK (TO-263) type A recommended footprint (dimensions are in mm)

4.2 D²PAK (TO-263) type B package information

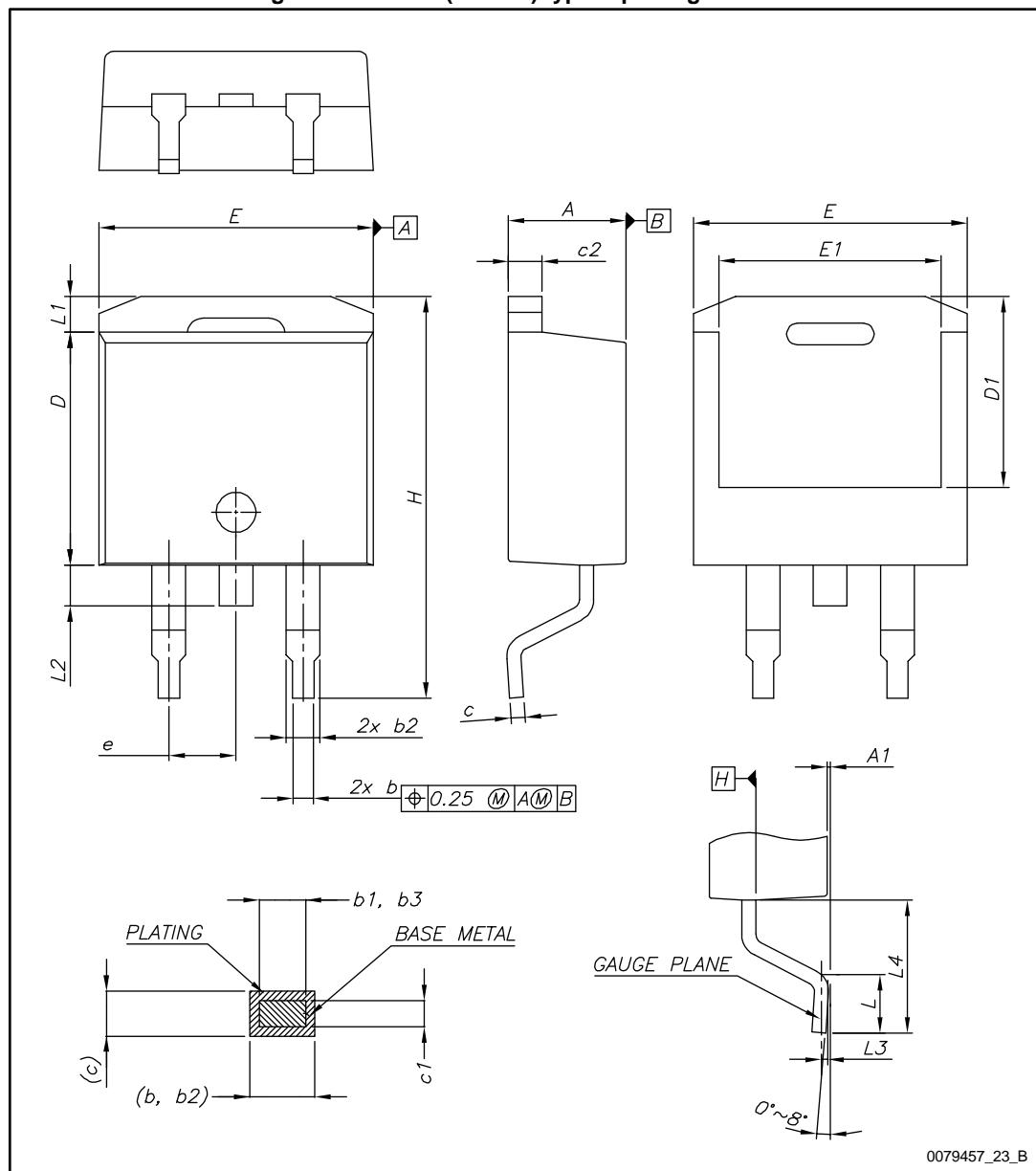
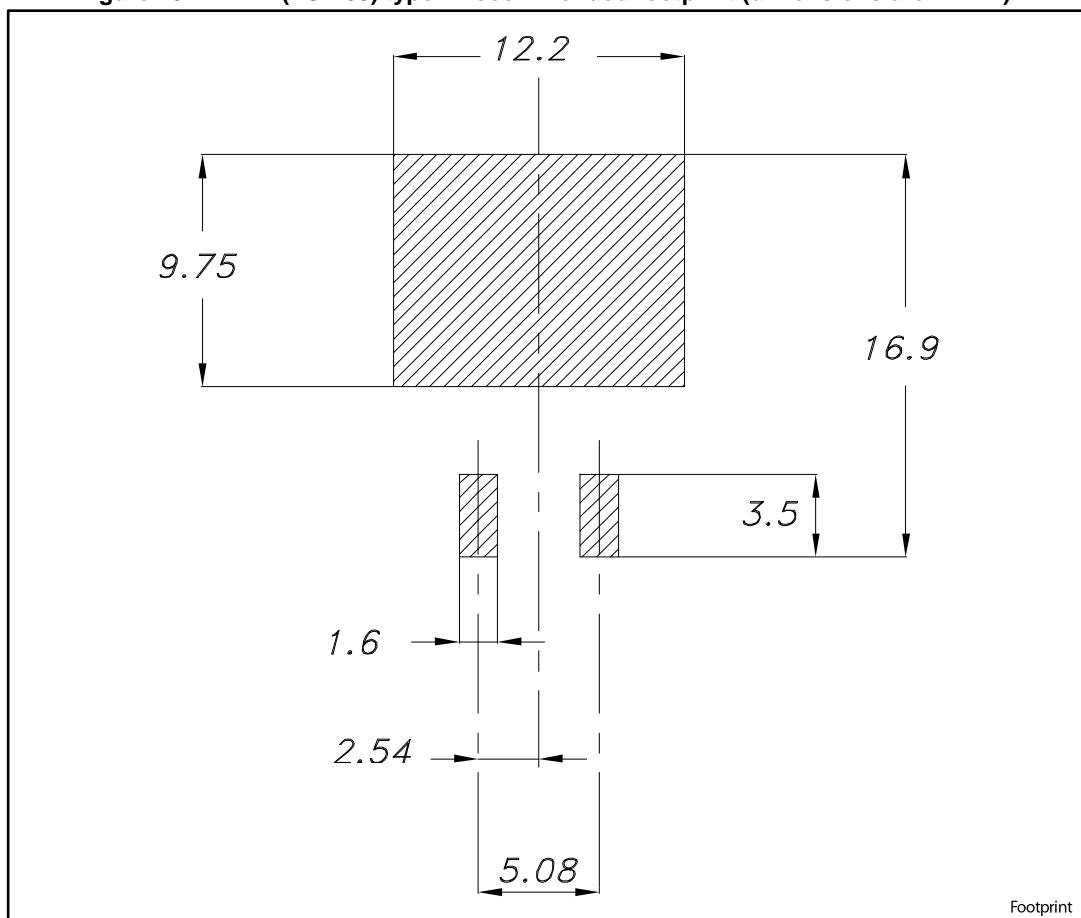
Figure 22: D²PAK (TO-263) type B package outline

Table 10: D²PAK (TO-263) type B mechanical data

| Dim. | mm | | |
|------|----------|------|-------|
| | Min. | Typ. | Max. |
| A | 4.36 | | 4.56 |
| A1 | 0 | | 0.25 |
| b | 0.70 | | 0.90 |
| b1 | 0.51 | | 0.89 |
| b2 | 1.17 | | 1.37 |
| b3 | 1.36 | | 1.46 |
| c | 0.38 | | 0.694 |
| c1 | 0.38 | | 0.534 |
| c2 | 1.19 | | 1.34 |
| D | 8.60 | | 9.00 |
| D1 | 6.90 | | 7.50 |
| E | 10.15 | | 10.55 |
| E1 | 8.10 | | 8.70 |
| e | 2.54 BSC | | |
| H | 15.00 | | 15.60 |
| L | 1.90 | | 2.50 |
| L1 | | | 1.65 |
| L2 | | | 1.78 |
| L3 | | 0.25 | |
| L4 | 4.78 | | 5.28 |

Figure 23: D²PAK (TO-263) type B recommended footprint (dimensions are in mm)

4.3 D2PAK type A packing information

Figure 24: D2PAK type A tape outline

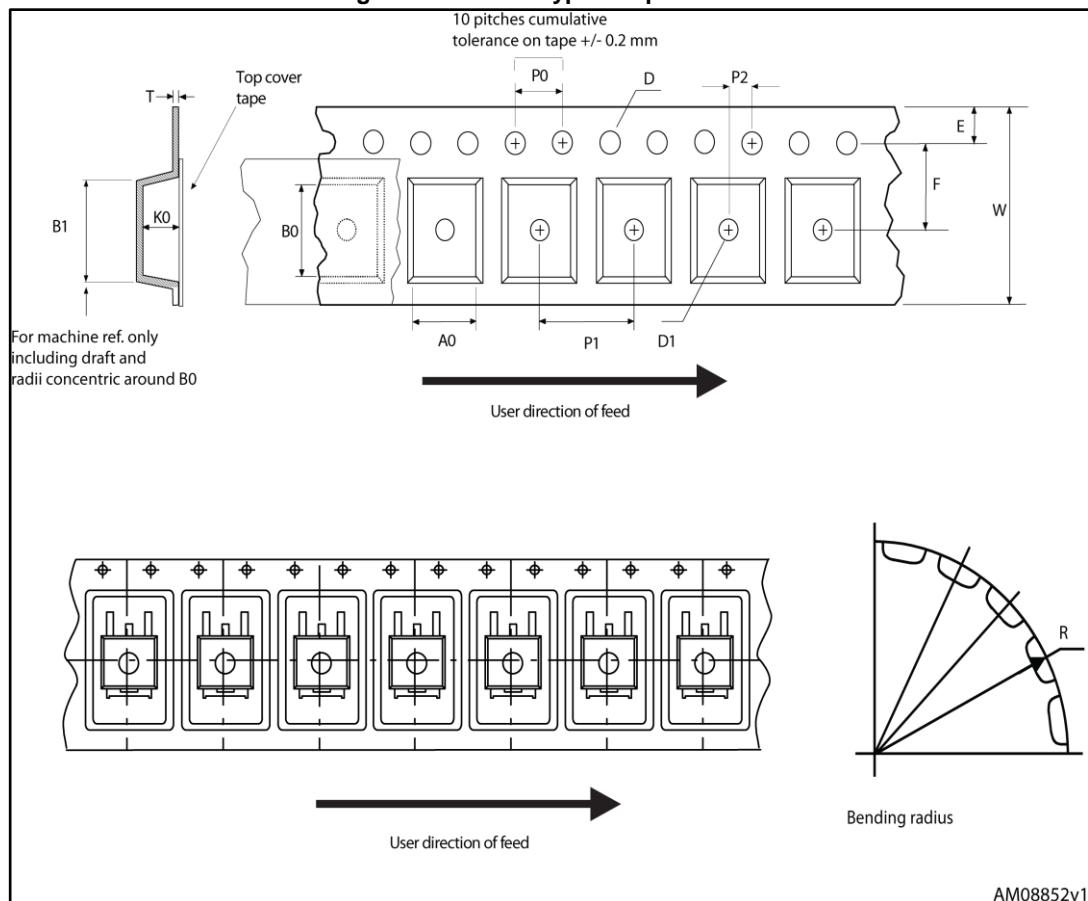
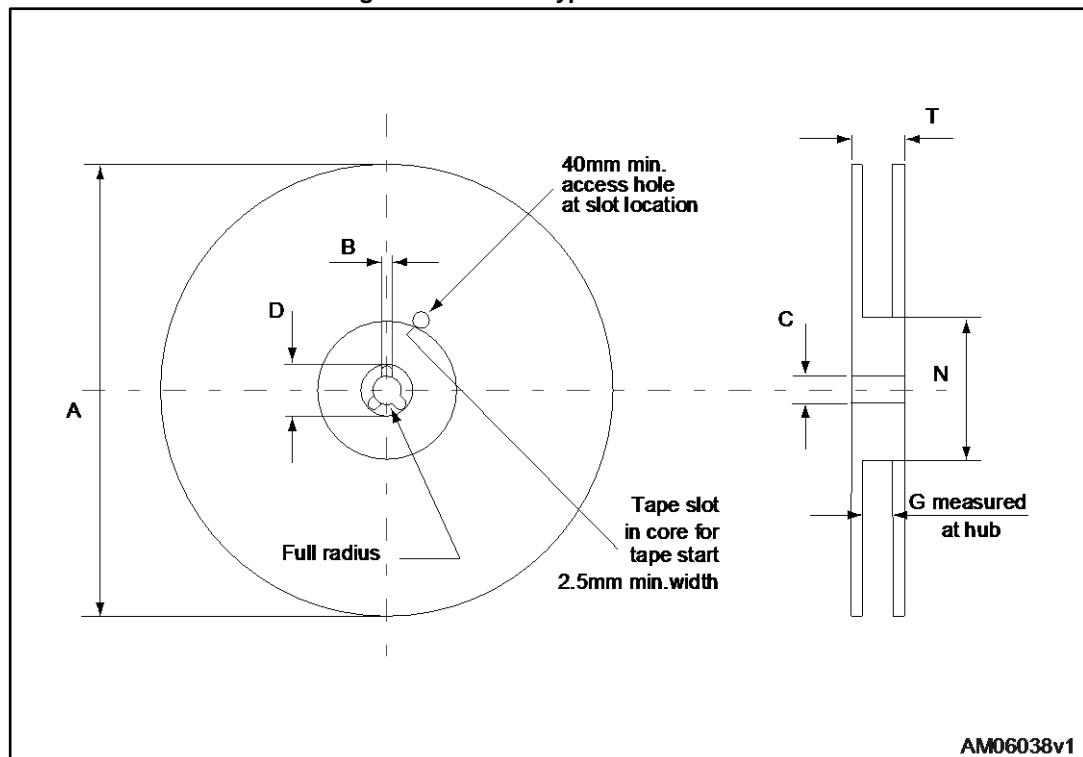


Figure 25: D2PAK type A reel outline

Table 11: D²PAK type A tape and reel mechanical data

| Tape | | | Reel | | |
|------|------|------|---------------|------|------|
| Dim. | mm | | Dim. | mm | |
| | Min. | Max. | | Min. | Max. |
| A0 | 10.5 | 10.7 | A | | 330 |
| B0 | 15.7 | 15.9 | B | 1.5 | |
| D | 1.5 | 1.6 | C | 12.8 | 13.2 |
| D1 | 1.59 | 1.61 | D | 20.2 | |
| E | 1.65 | 1.85 | G | 24.4 | 26.4 |
| F | 11.4 | 11.6 | N | 100 | |
| K0 | 4.8 | 5.0 | T | | 30.4 |
| P0 | 3.9 | 4.1 | | | |
| P1 | 11.9 | 12.1 | Base quantity | | 1000 |
| P2 | 1.9 | 2.1 | Bulk quantity | | 1000 |
| R | 50 | | | | |
| T | 0.25 | 0.35 | | | |
| W | 23.7 | 24.3 | | | |

4.4 D²PAK type B packing information

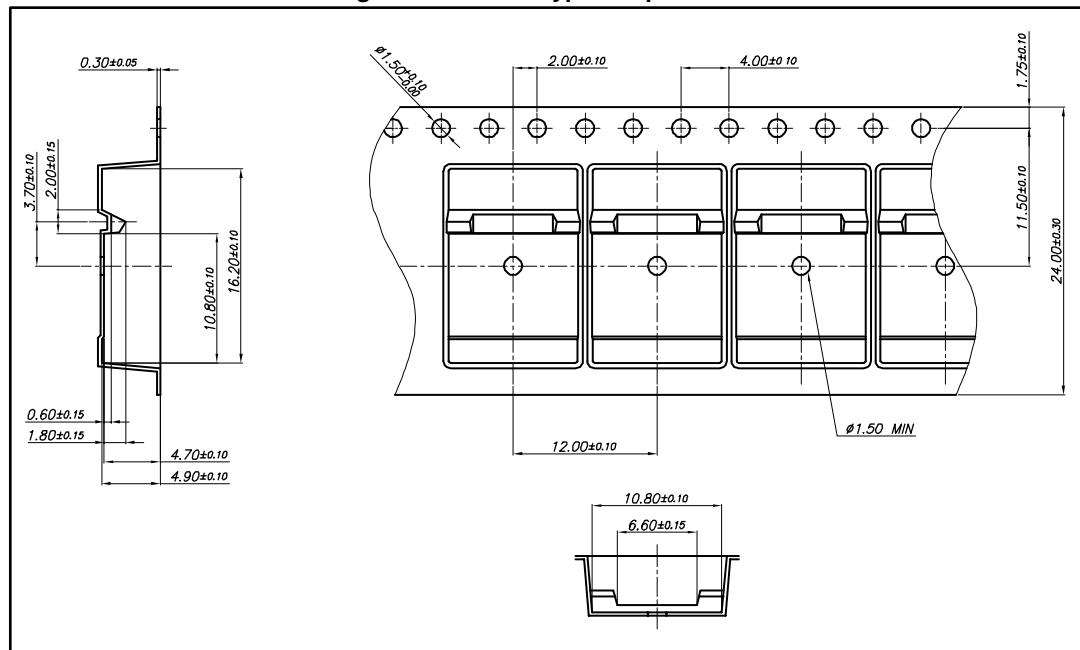
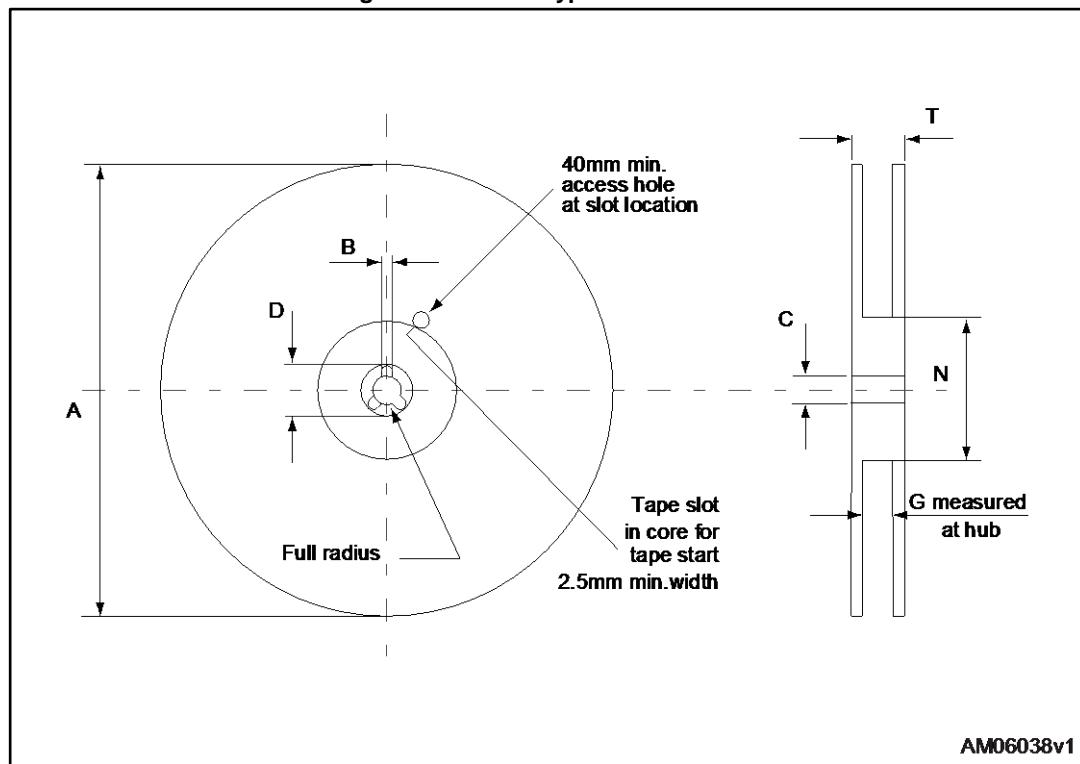
Figure 26: D²PAK type B tape outlineFigure 27: D²PAK type B reel outline

Table 12: D²PAK type B reel mechanical data

| Dim. | mm | |
|------|------|------|
| | Min. | Max. |
| A | | 330 |
| B | 1.5 | |
| C | 12.8 | 13.2 |
| D | 20.2 | |
| G | 24.4 | 26.4 |
| N | 100 | |
| T | | 30.4 |

5 Revision history

Table 13: Document revision history

| Date | Revision | Changes |
|-------------|----------|---|
| 08-Jan-2015 | 1 | Initial release. |
| 07-Apr-2016 | 2 | Updated <i>Table 2: "Absolute maximum ratings"</i> , <i>Table 6: "Dynamic"</i> , <i>Table 7: "Switching times"</i> and <i>Table 8: "Source-drain diode"</i> . |
| 06-Feb-2017 | 3 | Updated title, the table of features in cover page, <i>Section 1: "Electrical ratings"</i> and <i>Section 2: "Electrical characteristics"</i> . Added <i>Section 2.1: "Electrical characteristics (curves)"</i> . Added <i>Section 4.2: "D²PAK (TO-263) type B package information"</i> and <i>Section 4.4: "D²PAK type B packing information"</i> . Minor text changes. |
| 21-Mar-2017 | 4 | Updated document status from preliminary to production data. Updated <i>Table 2: "Absolute maximum ratings"</i> , <i>Table 6: "Dynamic"</i> and <i>Table 8: "Source-drain diode"</i> . Updated <i>Figure 2: "Safe operating area"</i> , <i>Figure 4: "Output characteristics"</i> , <i>Figure 5: "Transfer characteristics"</i> and <i>Figure 9: "Capacitance variations"</i> . |

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